TES Readout for Space

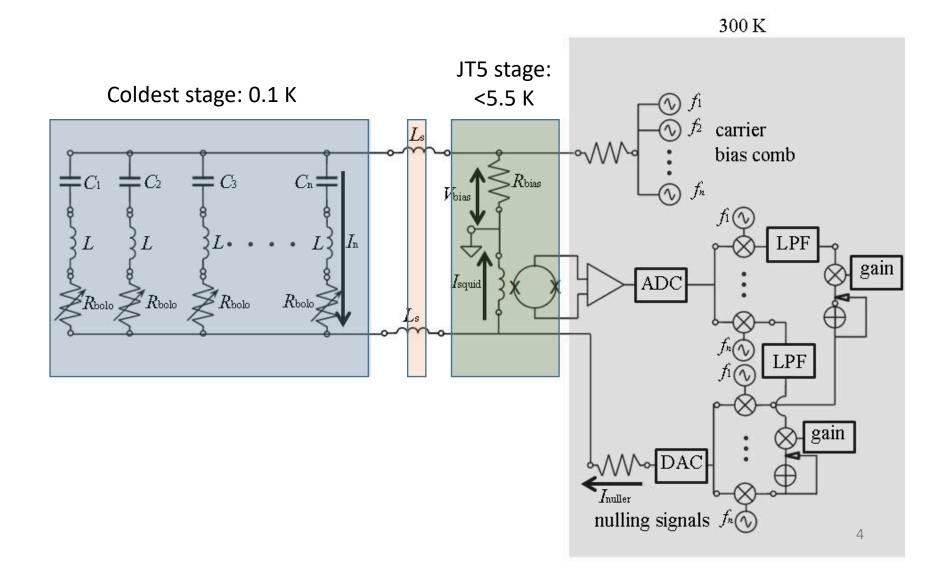
2017-12-05

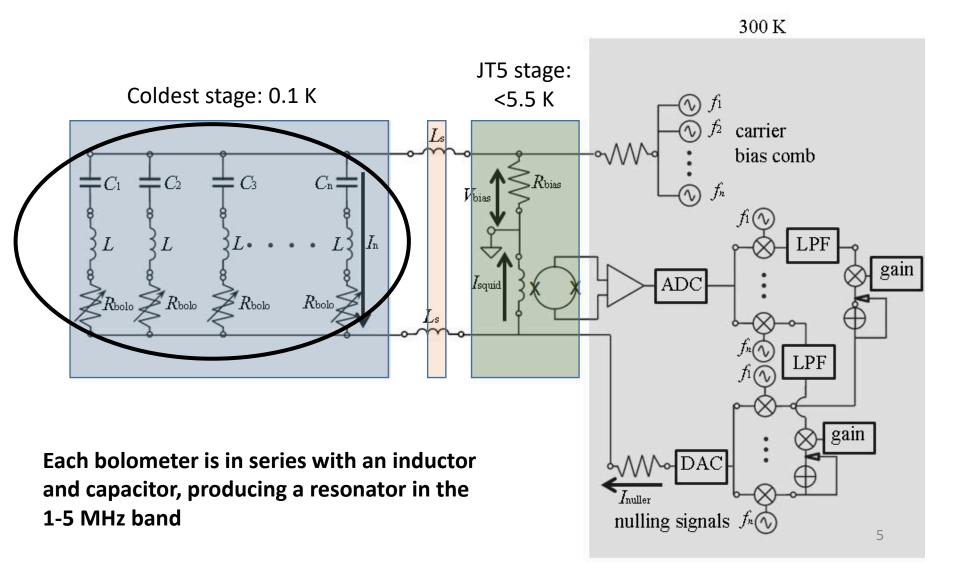
Kam Arnold, with input from Matt Dobbs, Zeesh Ahmed, Johannes Hubmayr, and others

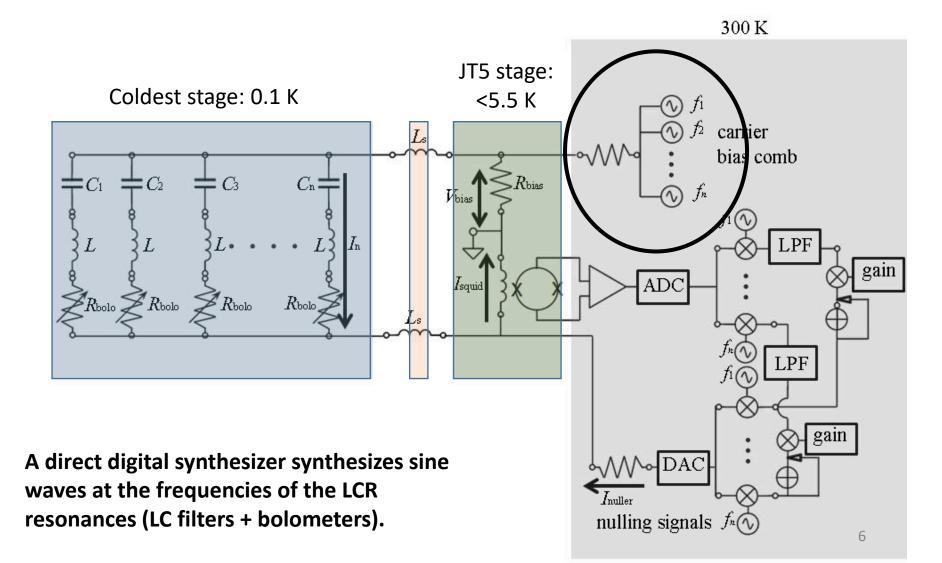
Outline

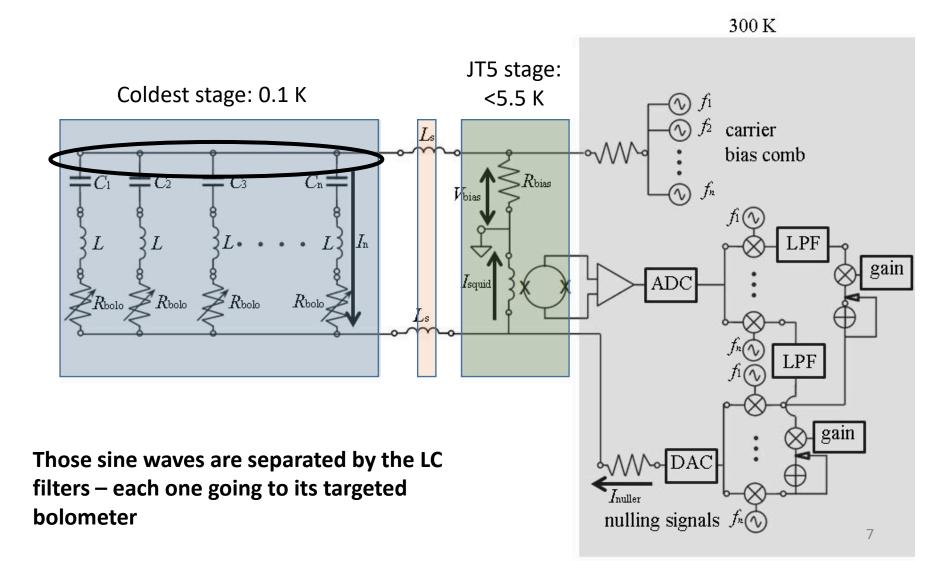
- Digital Frequency-Division Multiplexing (DfMux) MHz f-mux
 - Overview, Heritage & Status
 - "Warm readout" (outside the cryostat)
 - Existing development efforts for LiteBIRD funded by the Canadian Space Agency
 - "Cryogenic readout" (inside the cryostat)
 - Existing development efforts for LiteBIRD funded by NASA
- Microwave frequency-division multiplexing (μmux) – GHz f-mux
 - Status of this new readout scheme being developed for ground-based instruments

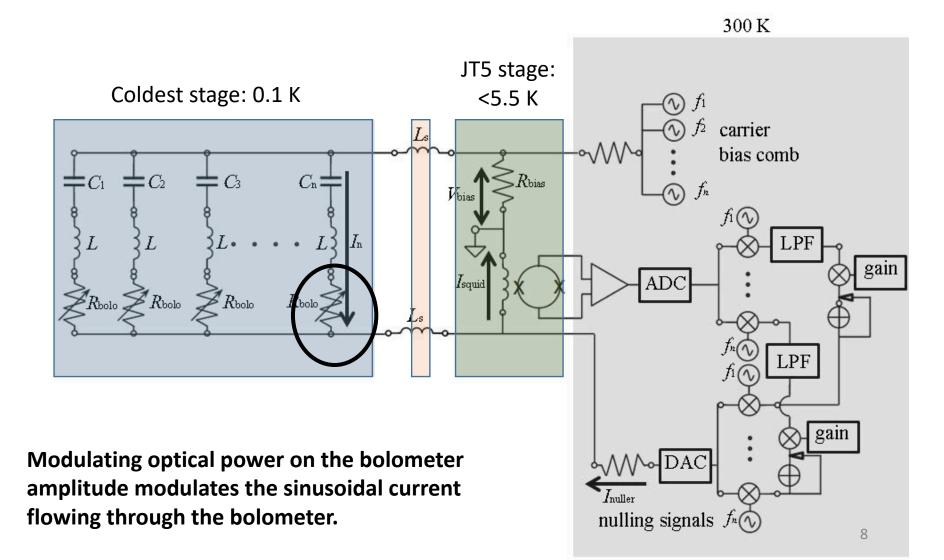
DfMux Overview, Heritage & Status

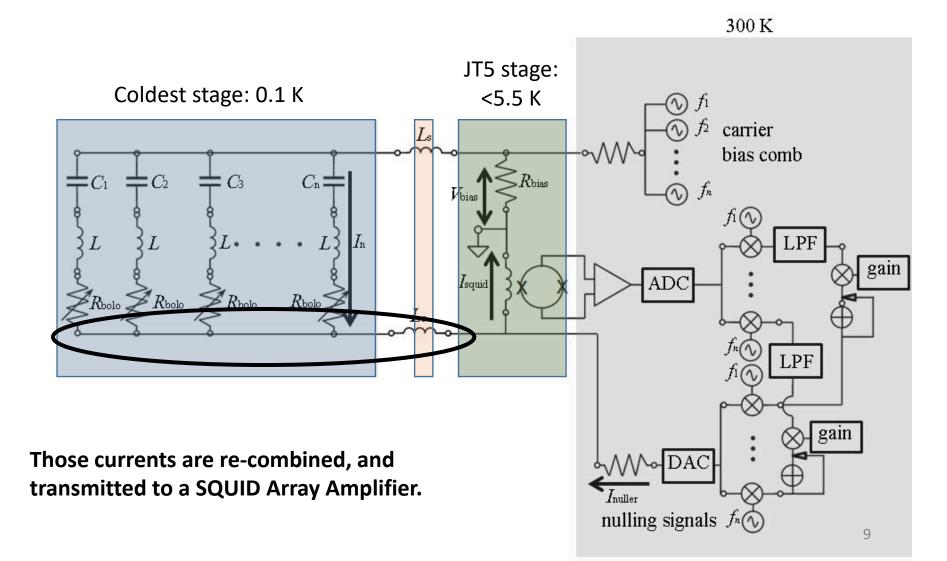


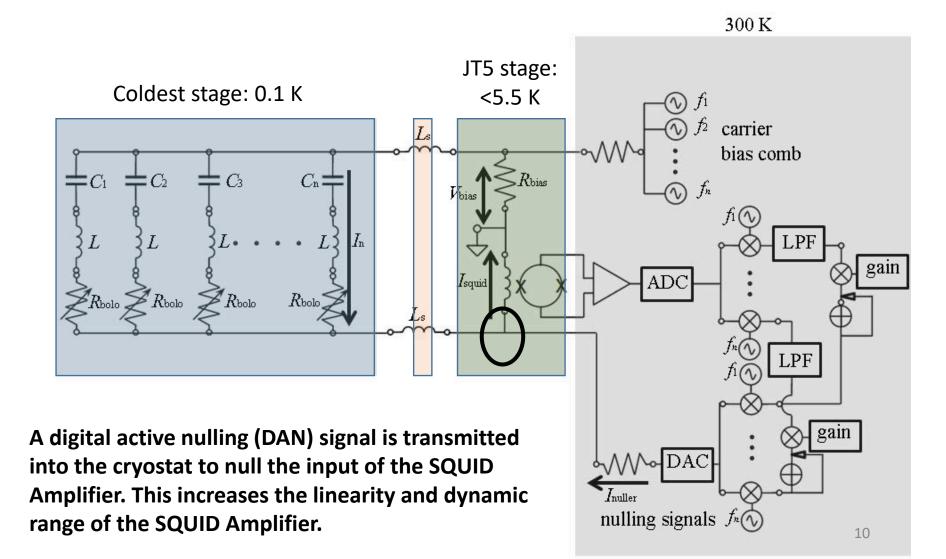


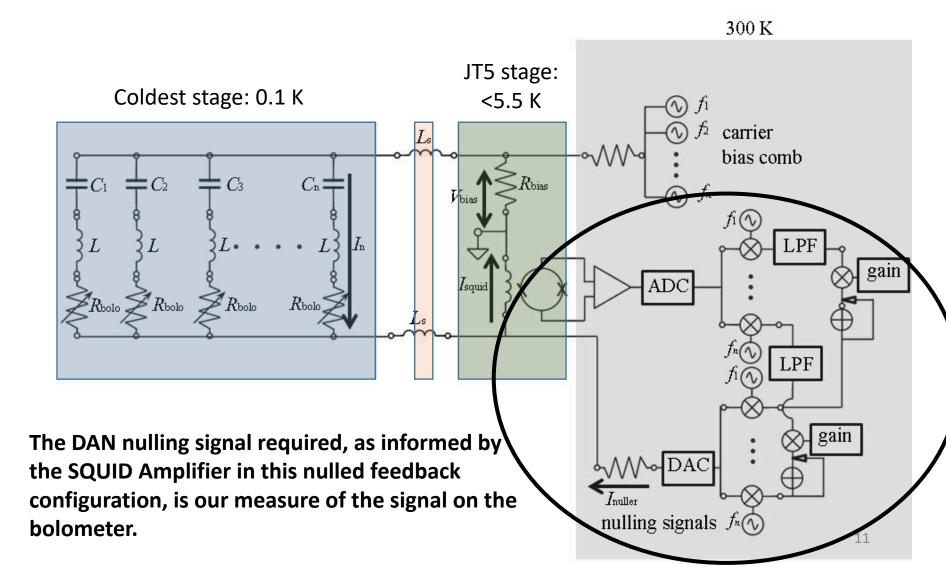




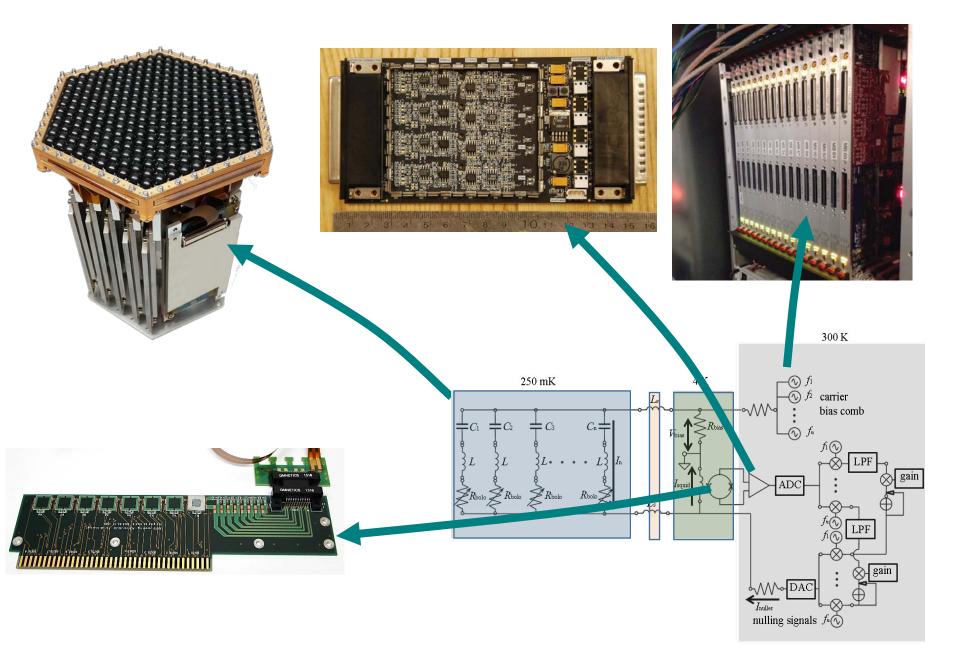








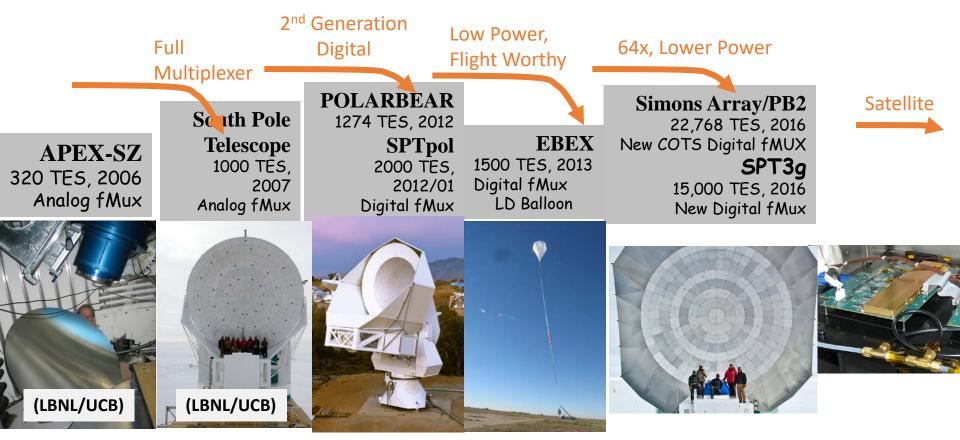
DfMux Readout: Ground-Based System



DfMux: Heritage

Warm Readout Developed at McGill University with industrial partner COMDEV/Honeywell.

- With strong collaboration from: UC Berkeley, U. Chicago, LBNL, NIST, UC San Diego.
- See: **A. Bender** *et al.,* "Digital frequency domain multiplexing readout electronics for the next generation of millimeter telescopes", **SPIE 2014 arXiv:1407.3161.**



Readout Requirements for Flight

- Given nominal detector parameters, the readout system should not increase the array noise by more than 10%.
 - This noise/sensitivity allocation is included in LiteBIRD sensitivity calculations.
 - Note that assembled yield is just as important, or more important, than fundamental increases in the detector noise.
- Several other requirements about low-frequency noise, gain stability, etc., captured in the US Concept Study Report (CSR)

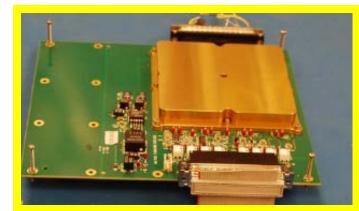
Current Readout TRL for flight

Intrument component	TRL	Sub-Component T	
Warm DfMux electronics	<u>3</u>		
		SQUID Controller	5
		Analog Mezzaniine Board	5
		FPGA Board	3
		FPGA VHDL Code	4
<u>Harness</u>	<u>3</u>		
		Mechanical	9
		Electrical	4
Cryogenic DfMux electronics	<u>3</u>		
		inductor/capacitor circuit	3
		inductor/capacitor chips	4
		sub-Kelvin wiring	3
		SQUID circuit	3
		SQUID chips	3

Current Warm Readout TRL - Detail

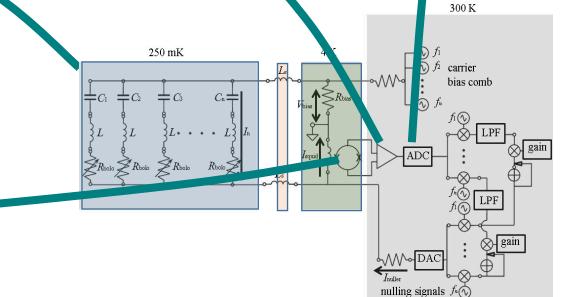
	TRL-3	TRL-4	TRL-5	TRL-6	
SQUID Controller Board (incorporating DAN) Analog Mezzanine Board (incorporating DAN)	Proof of concept test (modified EBEX board with cryo- bolometers)	 a) Updated board design for digital active nulling components b) Phase 1 boards tested with bolometers a) Updated board design for digital active nulling components b) Phase 1 boards tested with bolometers 	 a) Update board designs with flight representative components b) Boards tested together over temperature c) Boards tested with representative cryo bolometers & cryo SQUID 	System Demonstration with flight like boards, harnessing and flight like detector array & SQUIDs Temperature testing of boards (if required by TRL-5 results). Other environmental	
FPGA Board *	EBEX Boards	FPGA flight like design (SEU mitigation in place)	Flight like boards tested with above.	testing as required.	
FPGA VHDL Code *	EBEX VHDL Code	VHDL code modified for DAN	SEU monitoring to be demonstrated on EBEX flight		

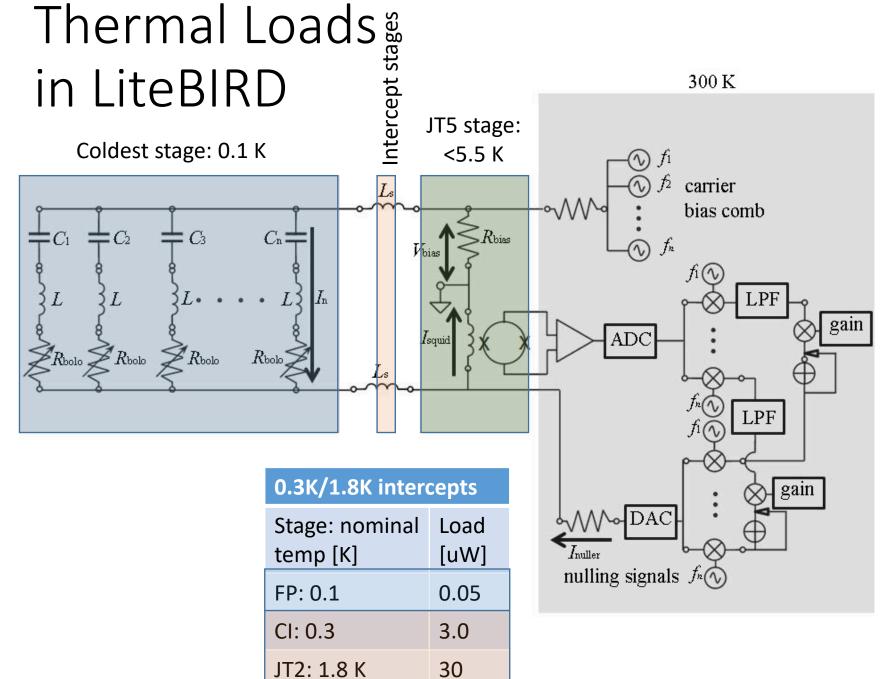
DfMux Readout: Warm analog system at TRL5



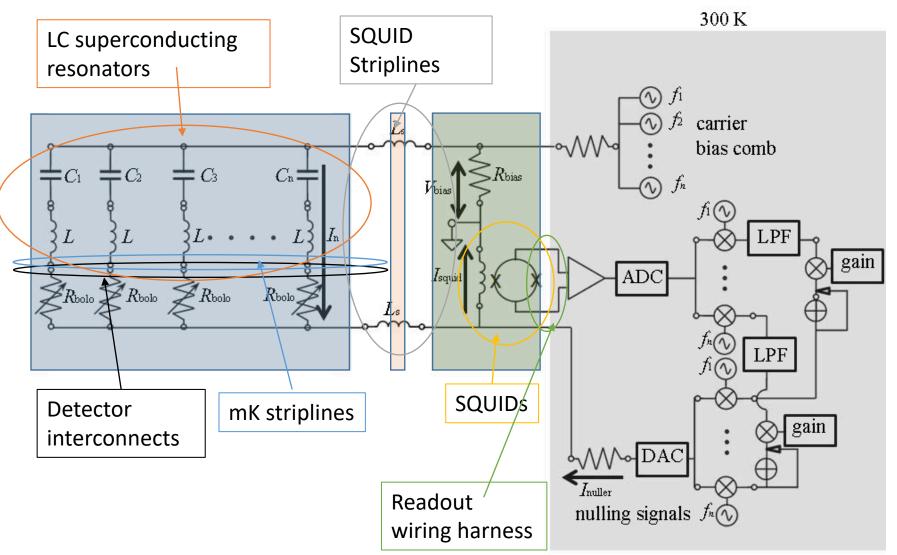


Flight packages to be designed this year as part of US NASA grant

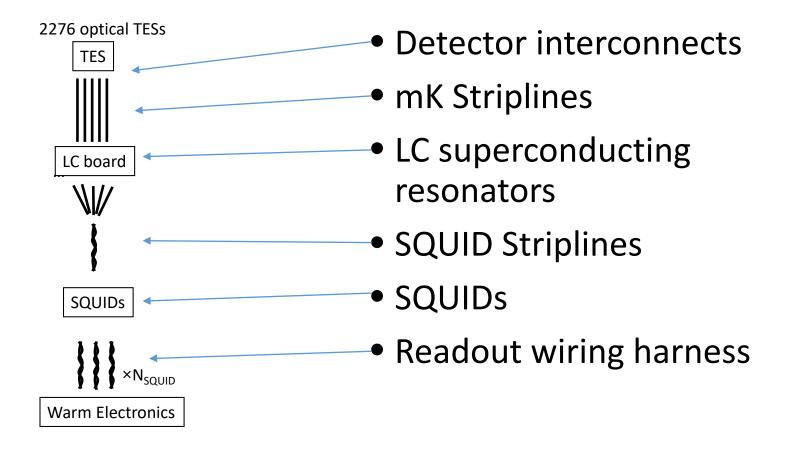




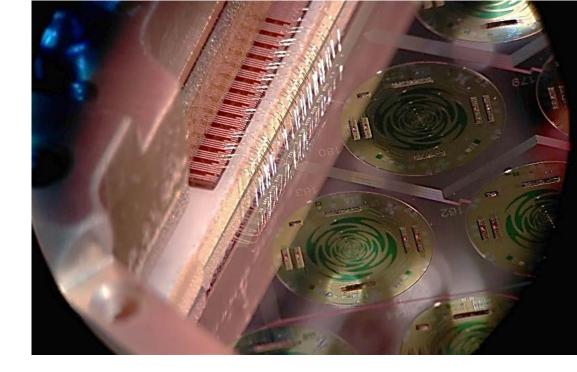
Cryogenic Readout Components



Cryogenic Readout Components

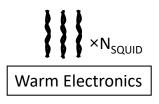


Detector interconnects



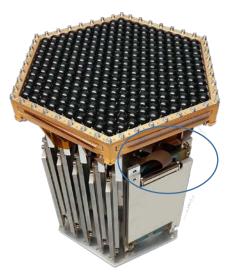
2276 optical TESs

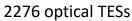


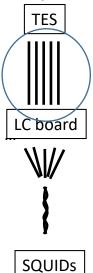


- Polarbear & SPT3G: Robust automatic wirebonding
 - Repeatable pull strength above NASA suggested requirements: <u>https://nepp.nasa.gov/index.cfm/20925</u>
 - Superconducting connection with resistance that is not a significant part of the series resistance budget. Range of series impedance allowed in circuit: **0.05 to 0.2 Ohms**
 - Repeatable inductance, part of inductance variation spec on next slide.
- Flight Solution to be fully validated

mK Striplines





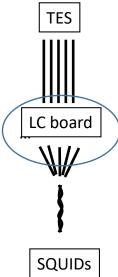


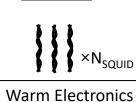
Warm Electronics

- Polarbear & SPT3G: copper on polyimid. Currently this satisfies requirements.
- Considering lithographed striplines to determine if there is benefit in robustness/packaging.
- Flight-like components coming in 2018 to reach TRL4

LC Superconducting Resonators

2276 optical TESs





• LiteBIRD: commercial Niobium solution

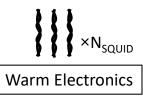
- Mechanical mounting to be designed.
- Recently demonstrated with 85% yield for POLARBEAR working on improving this.
- LC Radiation hardness: just Niobium on Si. If SQUIDs are OK, this is definitely OK.
- Flight-like components coming in 2018 to reach TRL4

SQUID Striplines

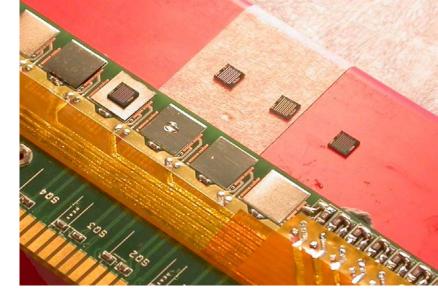
 Polarbear & SPT: NbTi on Kapton – 30 cm sections.

2276 optical TESs TES LC board SQUIDs

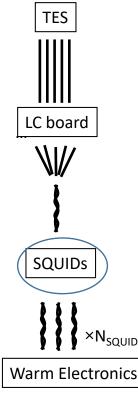
- Currently evaluating a lithographed solution for increased robustness and thermal performance.
- Flight-like components coming in 2018 to reach TRL4



SQUIDs

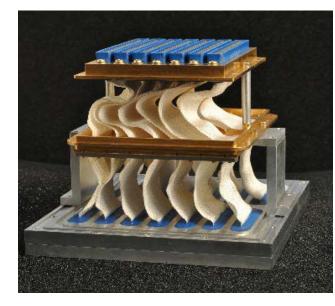


2276 optical TESs

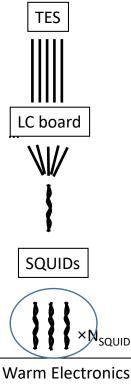


- Current SQUID Array Amplifiers have too much input inductance
 - Replacement SQUID Array being tested now on PB2 and SPT-3g
 - LiteBIRD solution may be to make a 2-stage amplifier: Initial SQUID Amplifier at 0.1 K, then a second-stage amplifier at 4 K.
 - As an amplifier system, there is a lot of work for space and ground right now to increase TRL.

Readout wiring harness



2276 optical TESs



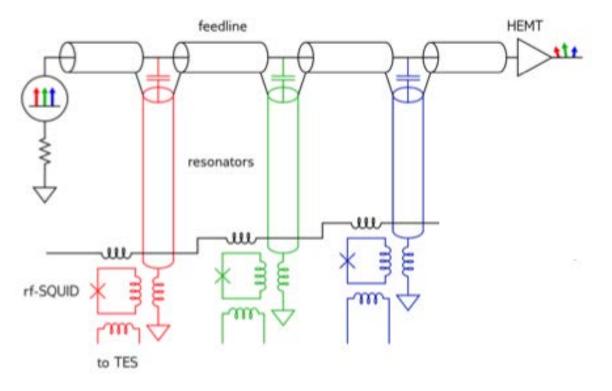
- Current system use short harnesses (see above)
- A spacecraft will require a long harness.
- Driving signals down the long harness with the SQUID is currently being tested. System will be validated by 2019.
 - Crosstalk and loss need to be controlled
 - Testing of SQUID Arrays and long harnesses now underway

Near-Term DfMux Readout Development

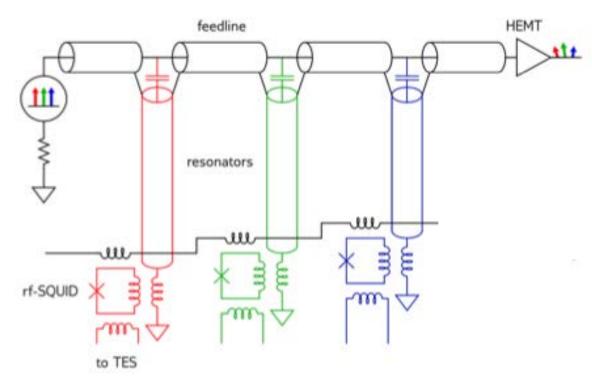
- Warm Readout: McGill funded (last month) by Canadian Space Agency to work on system interface issues
 - Systems-level work, including power converter, etc.
 - Develop FPGA/DSP motherboard to TRL5
 - Question of how to time FPGA work, given how fast the hardware develops here
- Cold Readout: US team funded (kick-off with NASA last week) to bring sub-systems to TRL5. Critical development issues:
 - Readout chain/interconnects: flight design coming in 2018
 - SQUID amplifier chain: input inductance and ability to drive wiring harness
 - Other developments in this program:
 - Bolometer cosmic ray sensitivity mitigation
 - Validate vibration insensitivity: launch survival and observing vibration conditions
 - Simulated observations including critical instrumental systematic effects as input to the LiteBIRD System Requirements Review

µMux – Overview & Status of Development

GHz resonators to multiplex TES bolometers

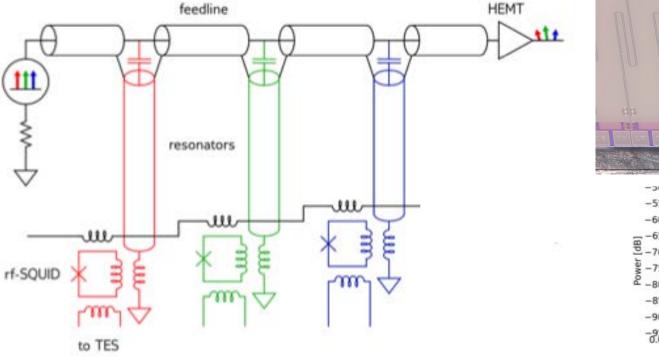


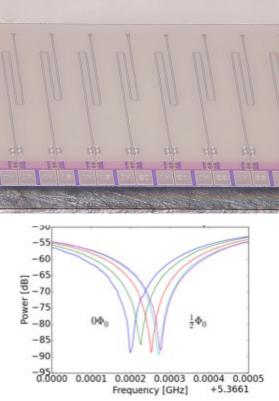
GHz resonators to multiplex TES bolometers



- Digitally synthesize a sum of sine waves to interrogate the resonators
- Mix those sine waves up into the 4-8 GHz band
- Amplify transmitted sine waves with lownoise amplifier at 4 K
- 4. Mix down and demodulate

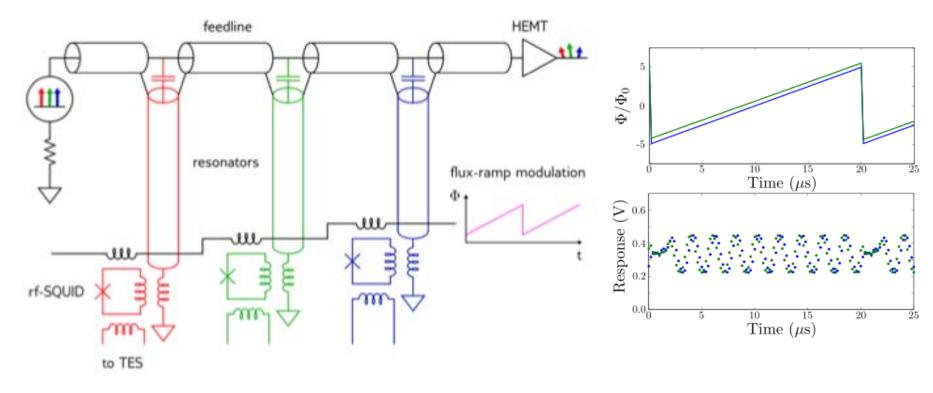
GHz resonators to multiplex TES bolometers





- Combine the immense multiplexability of microwave resonators with the heritage and maturity of TES and SQUIDs
- TES inductively couples to RF-SQUID, which screens a GHz resonator
- Signal in TES changes inductance, hence frequency of resonance. No change in Q

Microwave resonators to multiplex TES bolos (2)



- Flux modulation linearizes SQUID response
- Also mitigates the effect of low-frequency two-level system (TLS) noise in the resonator.

Recently Published lab performance of cold system

Low-frequency detector noise dominated by something that gets removed by common-mode subtraction – likely temperature fluctuations

Low-frequency noise in readout here dominated by voltage source – will be reduced substantially in future systems

